

< High Voltage Insulated Gate Bipolar Transistor : HVIGBT >

CM1200DC-34S1

HIGH POWER SWITCHING USE
INSULATED TYPE

CM1200DC-34S1



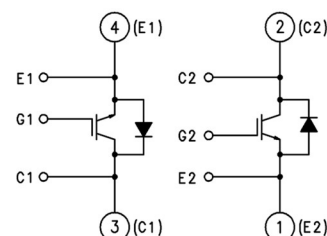
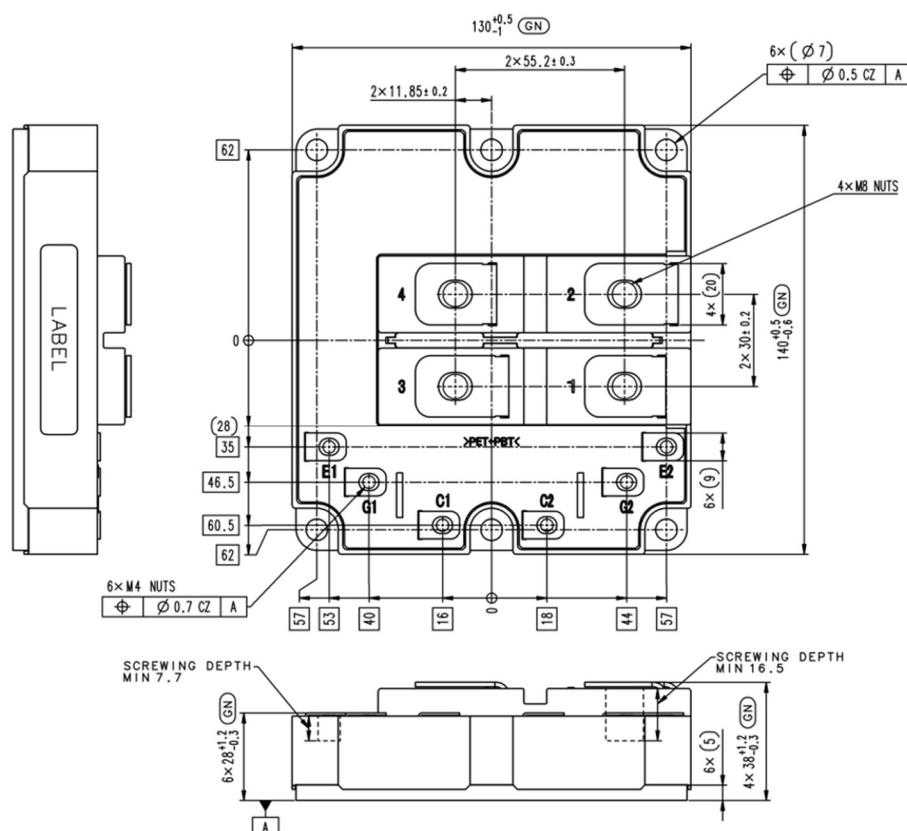
- I_C 1200A
- V_{CES} 1700V
- 2-elements in a Pack
- Insulated Type
- CSTBT™(III) / RFC Diode
- Flat Baseplate

APPLICATION

Traction drives, High Reliability Converters / Inverters, DC choppers

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



CIRCUIT DIAGRAM

< High Voltage Insulated Gate Bipolar Transistor : HVIGBT >

CM1200DC-34S1**HIGH POWER SWITCHING USE
INSULATED TYPE****MAXIMUM RATINGS**

Item	Symbol	Conditions	Ratings	Unit
Collector-emitter voltage Gate-emitter short-circuited	V_{CES}	$V_{GE} = 0 \text{ V}$	$T_J = -40 \sim +150 \text{ }^{\circ}\text{C}$ $T_J = -50 \text{ }^{\circ}\text{C}$	1700 1650 V
Gate-emitter voltage Collector-emitter short-circuited	V_{GES}	$V_{CE} = 0 \text{ V}$	$T_J = 25 \text{ }^{\circ}\text{C}$	± 20 V
Collector current	I_C	$T_c = 90 \text{ }^{\circ}\text{C}$, DC		1200 A
(Repetitive peak) Collector current	I_{CRM}	Pulse (Note 1)		2400 A
Emitter current	I_E	DC (Note 2)		1200 A
(Repetitive peak) Emitter current	I_{ERM}	Pulse (Note 1, 2)		2400 A
Total power dissipation	P_{tot}	$T_c = 25 \text{ }^{\circ}\text{C}$, IGBT part (Note 3)		6750 W
Isolation voltage	V_{isol}	Charged part to the baseplate RMS sinusoidal, 60Hz 1min		6000 V_{rms}
Partial discharge charge	Q_{pd}	Charged part to the baseplate, RMS sinusoidal, 60 Hz $V_1 = 3500 \text{ V}$, $V_2 = 2600 \text{ V}$, (acc. to IEC 61287-1)		10 pC
Junction temperature	T_J	Maximum temperature range in off-state or on-state (non-switching)		$-50 \sim +150$ $^{\circ}\text{C}$
Storage temperature	T_{stg}	Maximum case temperature range in off-state		$-50 \sim +150$ $^{\circ}\text{C}$
Operating junction temperature	T_{jop}	Maximum junction temperature range for switching operation		$-50 \sim +150$ $^{\circ}\text{C}$
Turn-off collector current	$I_{C(off)}$	$V_{GE} = \pm 15 \text{ V}$, $L_s = 70 \text{ nH}$, $R_{G(off)} = 3.3 \text{ } \Omega$, $V_{CC} \leq 1200 \text{ V}$, $V_{CE} \leq 1700 \text{ V}$	$T_J = 150 \text{ }^{\circ}\text{C}$	2400 A
Short-circuit withstand pulse duration	t_{SC}	$V_{GE} = \pm 15 \text{ V}$, $L_s \leq 70 \text{ nH}$, $R_{G(off)} = 3.3 \text{ } \Omega$, $V_{CC} \leq 1200 \text{ V}$, $V_{CE} \leq 1700 \text{ V}$	$T_J = 150 \text{ }^{\circ}\text{C}$	10 μs
Reverse recovery power dissipation	P_{rr}	$I_E = 2400 \text{ A}$, $L_s = 70 \text{ nH}$, $V_{CC} \leq 1200 \text{ V}$, $di/dt \leq 8000 \text{ A}/\mu\text{s}$, $V_{CE} \leq 1700 \text{ V}$	$T_J = 150 \text{ }^{\circ}\text{C}$	1.1 MW

ELECTRICAL CHARACTERISTICS

Item	Symbol	Conditions	Limits			Unit
			Min.	Typ.	Max.	
Collector-emitter cut-off current Gate-emitter short-circuited	I_{CES}	$V_{CE} = 1700 \text{ V}$, $V_{GE} = 0 \text{ V}$	$T_J = 25 \text{ }^{\circ}\text{C}$ $T_J = 125 \text{ }^{\circ}\text{C}$ $T_J = 150 \text{ }^{\circ}\text{C}$	- - -	4.0 1.8 40.0	mA mA mA
Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = 10 \text{ V}$, $I_C = 120 \text{ mA}$	$T_J = 25 \text{ }^{\circ}\text{C}$	5.40	6.00	6.60 V
Gate leakage current Collector-emitter short-circuited	I_{GES}	$V_{CE} = 0 \text{ V}$, $V_{GE} = \pm 20 \text{ V}$	$T_J = 25 \text{ }^{\circ}\text{C}$	-0.5	-	0.5 μA
Gate charge	Q_G	$V_{CC} = 850 \text{ V}$, $I_C = 1200 \text{ A}$, $V_{GE} = \pm 15 \text{ V}$	$T_J = 25 \text{ }^{\circ}\text{C}$	-	12.0	- μC
Input capacitance	C_{ies}	$V_{CE} = 10 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$	$T_J = 25 \text{ }^{\circ}\text{C}$	-	216	- nF
Output capacitance	C_{oes}	$V_{CE} = 10 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$	$T_J = 25 \text{ }^{\circ}\text{C}$	-	8.0	- nF
Reverse transfer capacitance	C_{res}	$V_{CE} = 10 \text{ V}$, $V_{GE} = 0 \text{ V}$, $f = 100 \text{ kHz}$	$T_J = 25 \text{ }^{\circ}\text{C}$	-	1.6	- nF
Collector-emitter saturation voltage	V_{CESat}	$I_C = 1200 \text{ A}$, $V_{GE} = +15 \text{ V}$ (Note 4)	$T_J = 25 \text{ }^{\circ}\text{C}$ $T_J = 125 \text{ }^{\circ}\text{C}$ $T_J = 150 \text{ }^{\circ}\text{C}$	- - -	1.95 2.25 2.30	- V 2.80 V
Emitter-collector voltage	V_{EC}	$I_E = 1200 \text{ A}$, $V_{GE} = 0 \text{ V}$ (Note 2, 4)	$T_J = 25 \text{ }^{\circ}\text{C}$ $T_J = 125 \text{ }^{\circ}\text{C}$ $T_J = 150 \text{ }^{\circ}\text{C}$	- - -	2.20 2.35 2.35	- V 2.85 V
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 850 \text{ V}$, $I_C = 1200 \text{ A}$, $V_{GE} = \pm 15 \text{ V}$, $L_s = 70 \text{ nH}$ $R_{G(on)} = 1.3 \text{ } \Omega$, $R_{G(off)} = 3.3 \text{ } \Omega$ Inductive load (Note 5)	$T_J = 150 \text{ }^{\circ}\text{C}$	-	-	1.10 μs
Rise time	t_r		$T_J = 150 \text{ }^{\circ}\text{C}$	-	-	0.41 μs
Turn-on (switching) energy per pulse 10% integral	$E_{on(10\%)}$		$T_J = 25 \text{ }^{\circ}\text{C}$ $T_J = 125 \text{ }^{\circ}\text{C}$ $T_J = 150 \text{ }^{\circ}\text{C}$	- - -	265 350 355	- mJ mJ mJ
Turn-on (switching) energy per pulse	E_{on}		$T_J = 25 \text{ }^{\circ}\text{C}$ $T_J = 125 \text{ }^{\circ}\text{C}$ $T_J = 150 \text{ }^{\circ}\text{C}$	- - -	290 370 380	- mJ mJ mJ

CM1200DC-34S1**HIGH POWER SWITCHING USE
INSULATED TYPE****ELECTRICAL CHARACTERISTICS**

Item	Symbol	Conditions		Limits			Unit
				Min.	Typ.	Max.	
Reverse recovery time	t_{rr}	$V_{CC} = 850\text{ V}$, $I_E = 1200\text{ A}$, $V_{GE} = \pm 15\text{ V}$, $L_s = 70\text{ nH}$ $R_{G(on)} = 1.3\ \Omega$, $R_{G(off)} = 3.3\ \Omega$ Inductive load(Note 2, 5, 6)	$T_J = 25\text{ }^{\circ}\text{C}$	-	0.30	-	μs
			$T_J = 125\text{ }^{\circ}\text{C}$	-	0.40	-	μs
			$T_J = 150\text{ }^{\circ}\text{C}$	-	0.45	-	μs
Reverse recovery current	I_{rr}		$T_J = 25\text{ }^{\circ}\text{C}$	-	735	-	A
			$T_J = 125\text{ }^{\circ}\text{C}$	-	865	-	A
			$T_J = 150\text{ }^{\circ}\text{C}$	-	875	-	A
Reverse recovery charge 10% integral	$Q_{rr(10\%)}$		$T_J = 25\text{ }^{\circ}\text{C}$	-	190	-	μC
			$T_J = 125\text{ }^{\circ}\text{C}$	-	295	-	μC
			$T_J = 150\text{ }^{\circ}\text{C}$	-	365	-	μC
Reverse recovered charge	Q_{rr}		$T_J = 25\text{ }^{\circ}\text{C}$	-	265	-	μC
			$T_J = 125\text{ }^{\circ}\text{C}$	-	340	-	μC
			$T_J = 150\text{ }^{\circ}\text{C}$	-	420	-	μC
Reverse recovery energy per pulse 10% integral	$E_{rec(10\%)}$		$T_J = 25\text{ }^{\circ}\text{C}$	-	90	-	mJ
			$T_J = 125\text{ }^{\circ}\text{C}$	-	150	-	mJ
			$T_J = 150\text{ }^{\circ}\text{C}$	-	195	-	mJ
Reverse recovery energy	E_{rec}		$T_J = 25\text{ }^{\circ}\text{C}$	-	150	-	mJ
			$T_J = 125\text{ }^{\circ}\text{C}$	-	190	-	mJ
			$T_J = 150\text{ }^{\circ}\text{C}$	-	240	-	mJ
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 850\text{ V}$, $I_C = 1200\text{ A}$, $V_{GE} = \pm 15\text{ V}$, $L_s = 70\text{ nH}$ $R_{G(on)} = 1.3\ \Omega$, $R_{G(off)} = 3.3\ \Omega$ Inductive load(Note 5)	$T_J = 25\text{ }^{\circ}\text{C}$	-	1.20	-	μs
			$T_J = 125\text{ }^{\circ}\text{C}$	-	1.30	-	μs
			$T_J = 150\text{ }^{\circ}\text{C}$	-	1.32	-	μs
Fall time	t_f		$T_J = 25\text{ }^{\circ}\text{C}$	-	0.12	-	μs
			$T_J = 125\text{ }^{\circ}\text{C}$	-	0.15	-	μs
			$T_J = 150\text{ }^{\circ}\text{C}$	-	0.17	-	μs
Turn-off (switching) energy per pulse 10% integral	$E_{off(10\%)}$		$T_J = 25\text{ }^{\circ}\text{C}$	-	200	-	mJ
			$T_J = 125\text{ }^{\circ}\text{C}$	-	280	-	mJ
			$T_J = 150\text{ }^{\circ}\text{C}$	-	310	-	mJ
Turn-off (switching) energy per pulse	E_{off}		$T_J = 25\text{ }^{\circ}\text{C}$	-	260	-	mJ
			$T_J = 125\text{ }^{\circ}\text{C}$	-	360	-	mJ
			$T_J = 150\text{ }^{\circ}\text{C}$	-	400	-	mJ

Note1. Pulse width and repetition rate should be such that junction temperature (T_j) does not exceed T_{jopmax} rating.

Note2. The symbols represent characteristics of the anti-parallel, emitter to collector free-wheel diode (FWD).

Note3. Junction temperature (T_j) should not exceed T_{jmax} rating (150°C).

Note4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

Note5. The integration range of switching energies($E_{on(10\%)}$, $E_{rec(10\%)}$, $E_{off(10\%)}$) is from $10\%V_{CE}$ to $10\%I_C(10\%I_E)$.Note6. The integration range of reverse recovery charge($Q_{rr(10\%)}$) is from $I_E = 0\text{A}$ to $10\%I_E$.

CM1200DC-34S1**HIGH POWER SWITCHING USE
INSULATED TYPE****THERMAL CHARACTERISTICS**

Item	Symbol	Conditions	Limits			Unit
			Min.	Typ.	Max.	
Thermal resistance junction to case, IGBT	$R_{th(j-c)Q}$	Junction to Case, IGBT part, 1/2 module	-	-	18.5	K/kW
Thermal resistance Junction to case, DIODE	$R_{th(j-c)D}$	Junction to Case, FWDi part, 1/2 module	-	-	38.0	K/kW
Contact thermal resistance case to heatsink	$R_{th(c-s)}$	Case to heat sink, 1/2 module $\lambda_{grease} = 1 \text{ W/m}\cdot\text{k}$, $D_{(c-s)} = 100 \text{ }\mu\text{m}$	-	16.0	-	K/kW

MECHANICAL CHARACTERISTICS

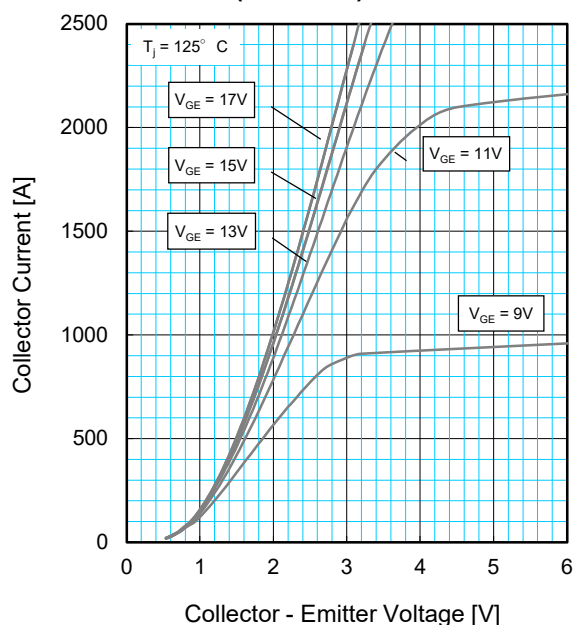
Item	Symbol	Conditions	Limits			Unit
			Min.	Typ.	Max.	
Mounting torque	M_t	Main terminals screw: M8	7.0	-	20.0	N·m
Mounting torque		Mounting screw: M6	3.0	-	6.0	N·m
Mounting torque		Auxiliary terminals screw: M4	1.0	-	3.0	N·m
Mass	m	-	-	0.8	-	kg
Comparative tracking index	CTI	-	600	-	-	-
Clearance distance in air	d_a	Collector main terminal - Emitter main terminal Terminal - Baseplate	9.5	-	-	mm
Creepage distance along surface	d_s	Collector main terminal - Emitter main terminal	15.0	-	-	mm
Creepage distance along surface	d_s	Terminal - Baseplate	15.0	-	-	mm
Internal inductance (C-E)	$L_{P(C-E)}$	1/2 module, IGBT part, $T_c=25^\circ\text{C}$	-	22	-	nH
Internal lead resistance, CC'-EE'	$R_{CC'+EE'}$	1/2 module, IGBT part, $T_c=25^\circ\text{C}$	-	0.16	-	mΩ

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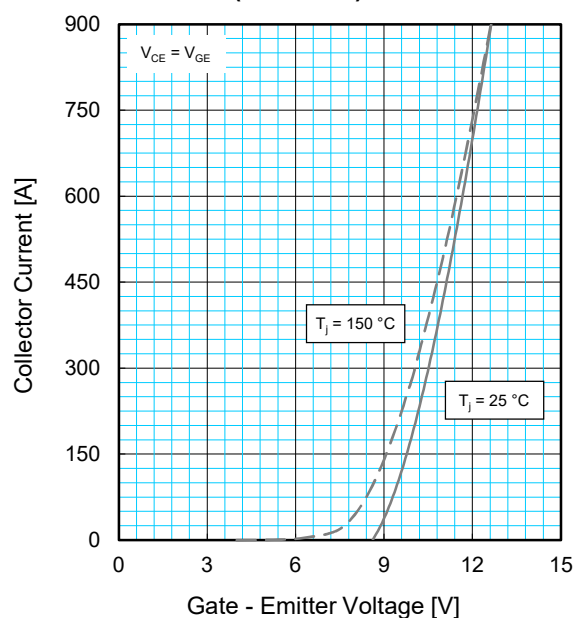
HIGH POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

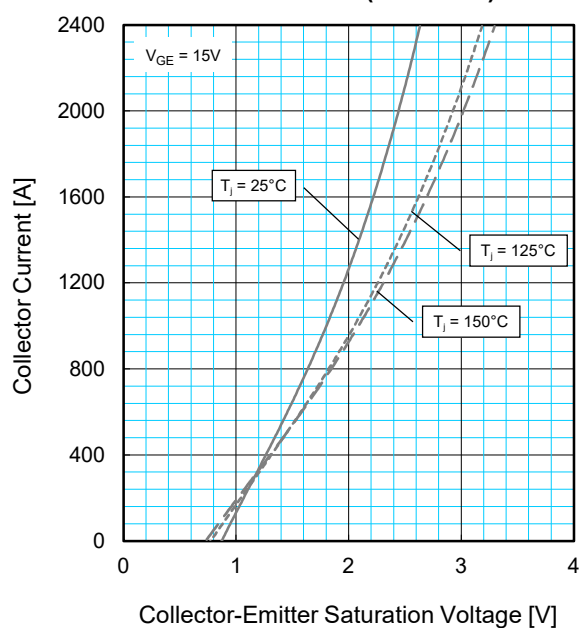
OUTPUT CHARACTERISTICS
(TYPICAL)



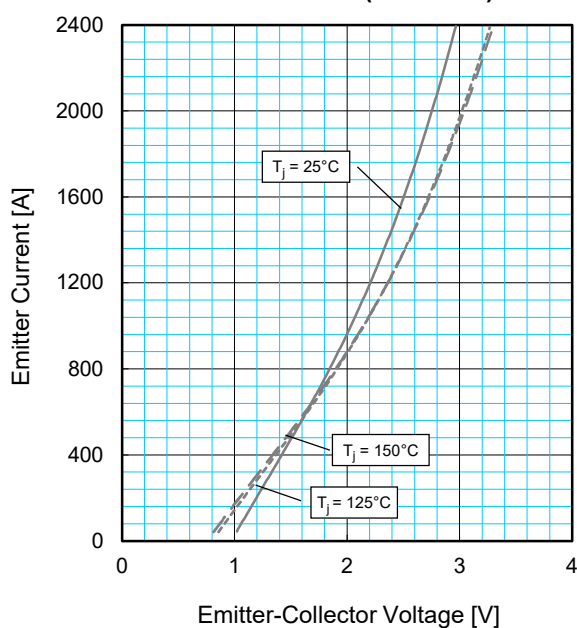
TRANSFER CHARACTERISTICS
(TYPICAL)



COLLECTOR-EMITTER SATURATION VOLTAGE
CHARACTERISTICS (TYPICAL)



FREE-WHEEL DIODE FORWARD
CHARACTERISTICS (TYPICAL)

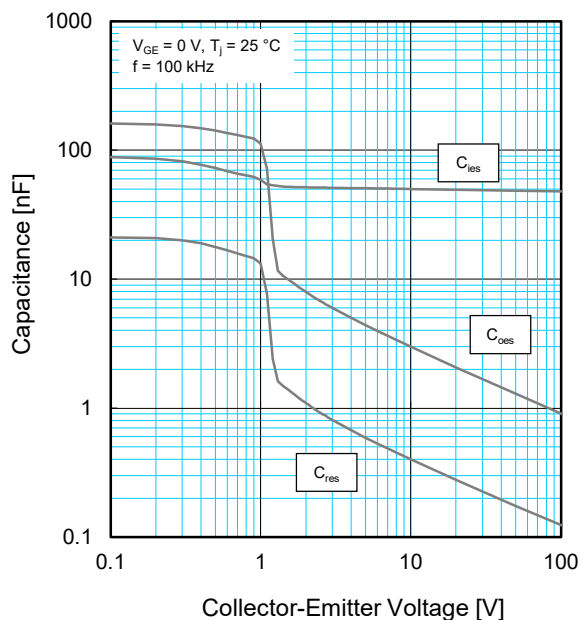


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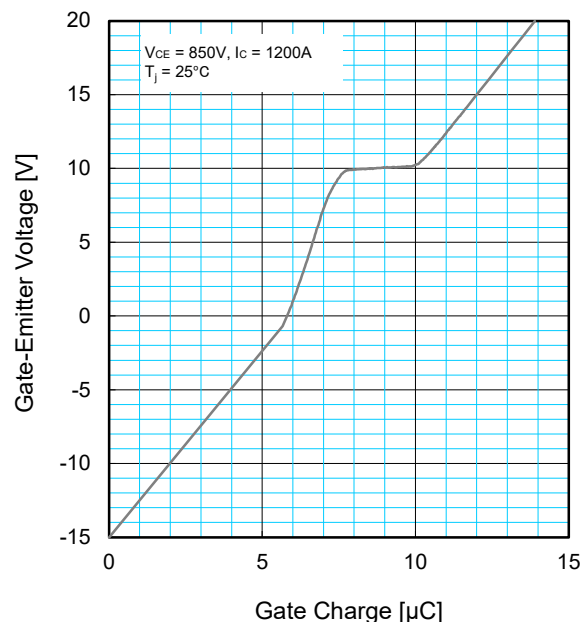
HIGH POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

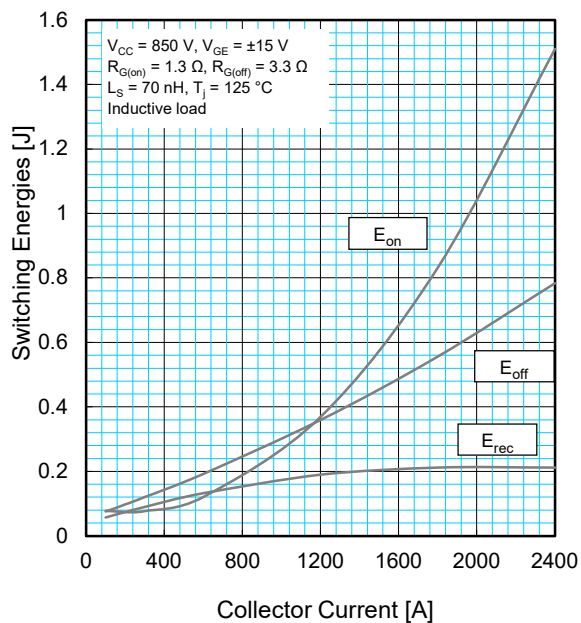
CAPACITANCE CHARACTERISTICS
(TYPICAL)



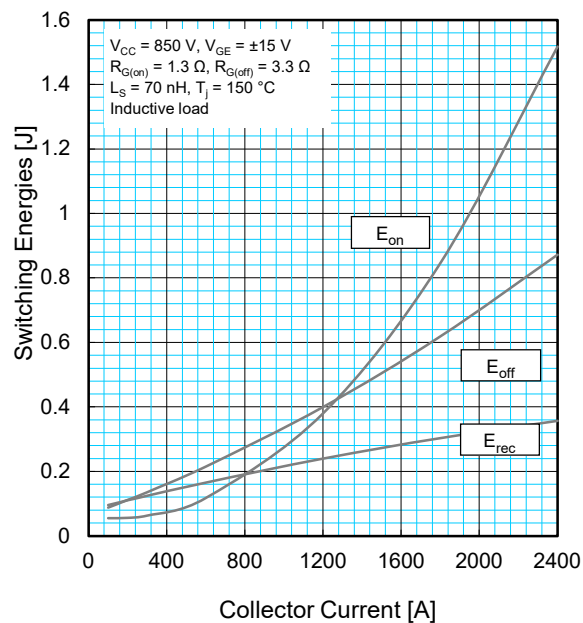
GATE CHARGE CHARACTERISTICS
(TYPICAL)



HALF-BRIDGE SWITCHING ENERGY
CHARACTERISTICS (TYPICAL)



HALF-BRIDGE SWITCHING ENERGY
CHARACTERISTICS (TYPICAL)

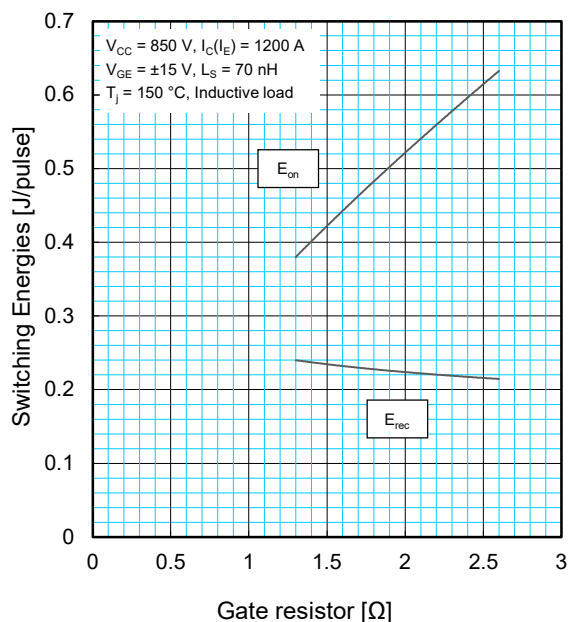


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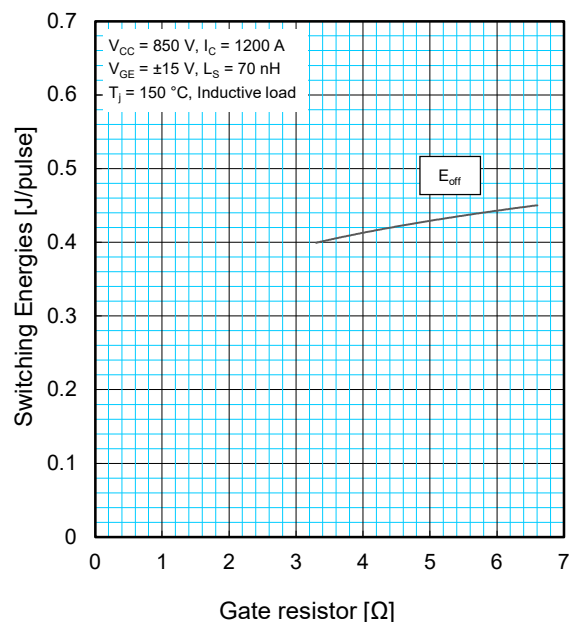
HIGH POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

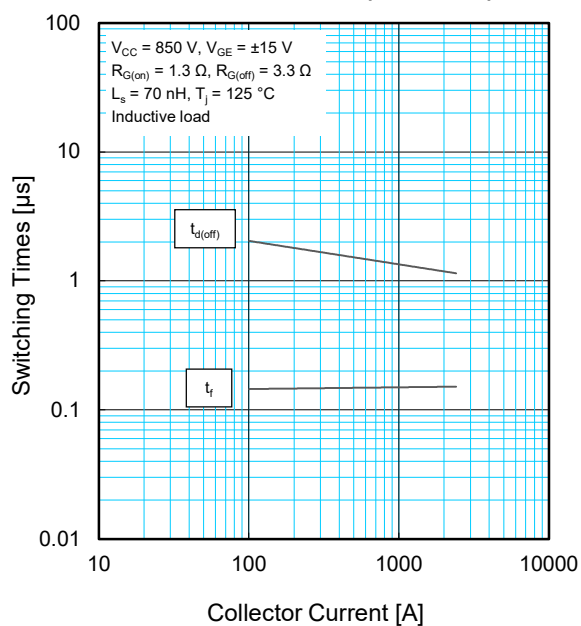
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



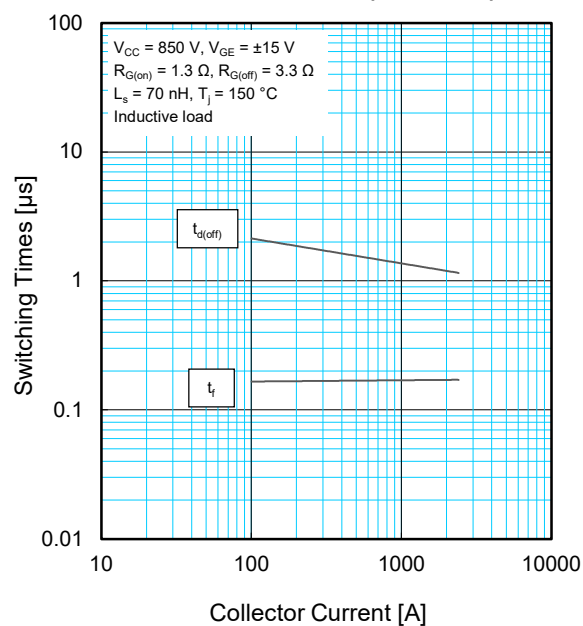
HALF-BRIDGE SWITCHING ENERGY CHARACTERISTICS (TYPICAL)



HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)

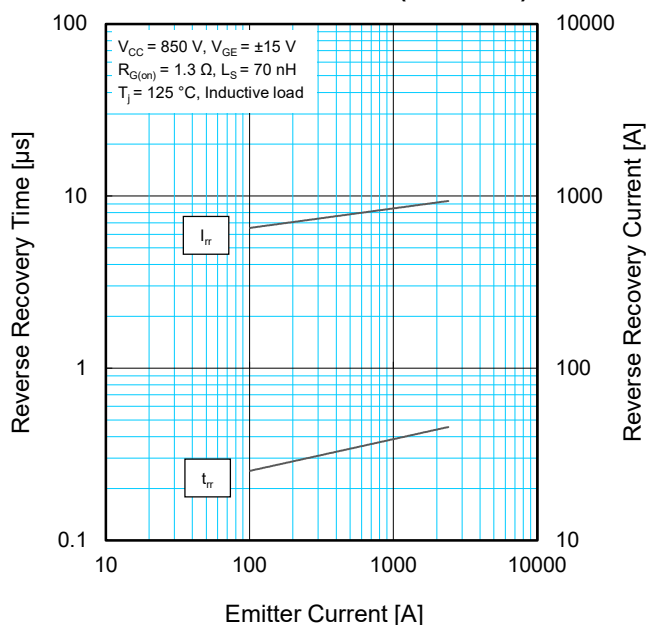


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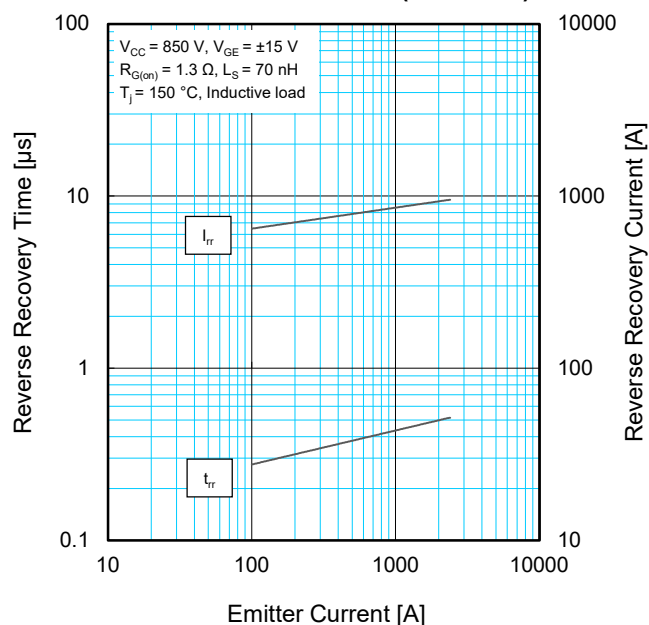
HIGH POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

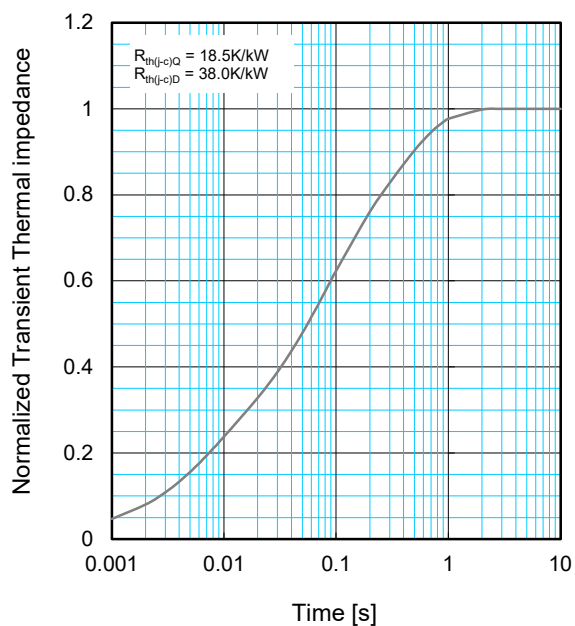
FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



FREE-WHEEL DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



$$Z_{th(j-c)}(t) = \sum_{i=1}^n R_i \left\{ 1 - \exp\left(-\frac{t}{\tau_i}\right) \right\}$$

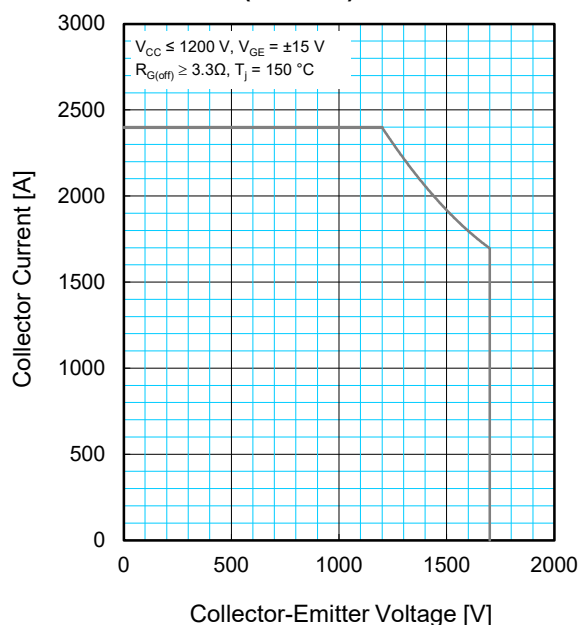
	1	2	3	4
R_i [K/kW] :	0.0096	0.1893	0.4044	0.3967
τ_i [sec.] :	0.0001	0.0058	0.0602	0.3512

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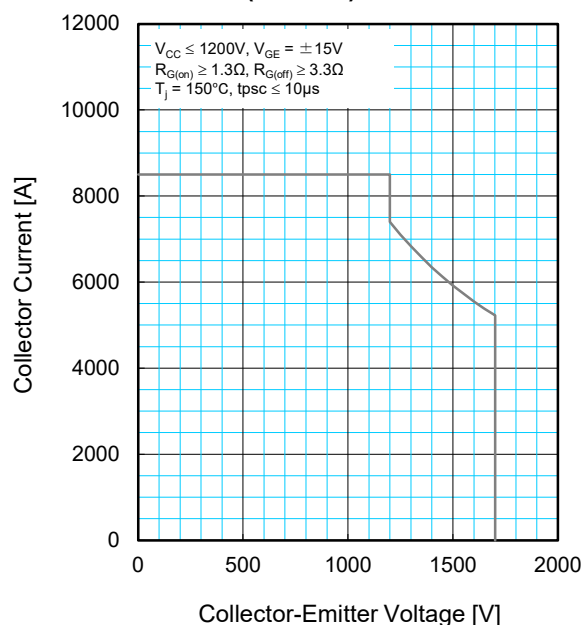
HIGH POWER SWITCHING USE
INSULATED TYPE

PERFORMANCE CURVES

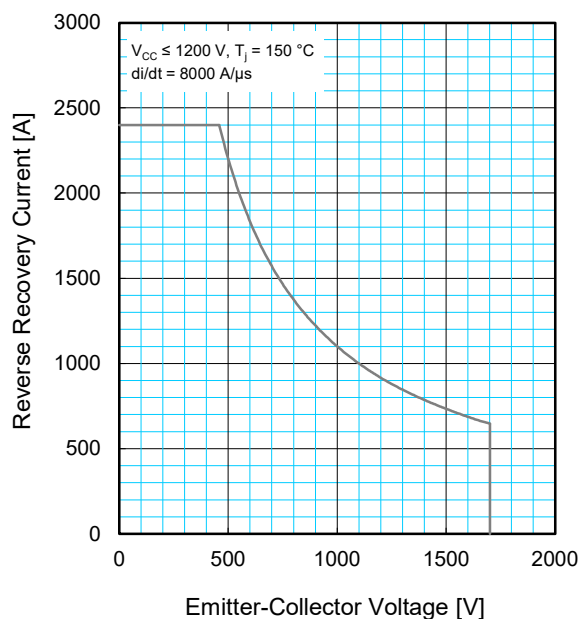
REVERSE BIAS SAFE OPERATING AREA (RBSOA)



SHORT CIRCUIT SAFE OPERATING AREA (SCSOA)



FREE-WHEEL DIODE REVERSE RECOVERY SAFE OPERATING AREA (RRSOA)



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HIGH POWER SWITCHING USE
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